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1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Byeong-yun NAM and Byong-Sun JU	Name: Samsung Electronics Co., Ltd.
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8/211.0	
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3. Nature of Conveyance:	
Assignment Interview Merger Security Agreement Change of Name Other	
Execution Date(s): August 7, 1998	
4. Application number(s) or patent number(s):	128655
If this document is being filed together with a new applica date of the application is <u>August 24, 1998</u>	on, the execution
A. Patent Application No(s).	B. Patent No(s).
Additional numbers attached?	yes 🛛 no
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To the best of my knowledge and belief, the foregoing information original document. <u>Ioseph V. Colaianni, Ir.</u> Name of Person Signing	n is true and correct and any attached copy is a true copy of the <u>August 24, 1998</u> Date humber of pages including cover sheet, attachments and document <u>3</u>
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## 08/31/1998 NUILLARI 00000082 09138655

## **ASSIGNMENT**

In consideration of the sum of One Dollar (\$1.00) or equivalent and other good and valuable consideration paid to the undersigned: Byeong-yun NAM and Byong-sun JU, the undersigned hereby sell and assign to <u>SAMSUNG ELECTRONICS CO., LTD.</u> (the Assignee), their entire right, title and interest

*check applicable box(es)* **(25) (25) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (26) (2** 

■: and throughout the world,

in the invention known as <u>Method for Etching A Platinum Layer in A Semiconductor</u> <u>Device</u>, for which application for patent in the United States of America has been executed by the undersigned on \_\_\_\_\_\_\_\_\_ (also known as United States Application No. \_\_\_\_\_\_\_, filed \_\_\_\_\_\_\_), in any and all applications thereon, in any and all Letters Patent(s) therefor, and in any and all reissues, extensions, renewals, reexaminations of such applications or Letters Patent(s) and divisional and continuation applications thereof, to the full end of the term or terms for which such Letters Patent(s) issue, including all claims, if any, that may have arisen for infringement prior to the date of this assignment, such entire right, title and interest to be held and enjoyed by the above-named Assignee to the same extent as they would have been held and enjoyed by the undersigned had this assignment and sale not been made.

The undersigned agree to execute all papers necessary in connection with the application and any continuing (continuation, divisional, or continuation-in-part), reissue, reexamination or corresponding application(s) thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree to execute all papers necessary in connection with any interference that may be declared concerning the application or any continuing (continuation, divisional, or continuation-in-part), reissue or reexamination application thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned hereby represent that the undersigned has full right to convey the entire interest herein assigned, and that the undersigned has not executed, and will not execute, any agreement in conflict therewith. The undersigned hereby grants:

Jeffrey I. Auerbach, Reg. No. 32,680 Melvin L. Barnes, Jr. Reg. No. 38,375 Michael J. Bell, Reg. No. 39,604 Mark R. Buscher, Reg. No. 35,006 Celine T. Callahan, Reg. No. 34,301 Cono A. Carrano, Reg. No. 34,301 Cono A. Carrano, Reg. No. 39,623 Joseph V. Colaianni, Reg. No. 39,948 James F. Davis, Reg. No. 21,072 Thomas M. Dunham, Reg. No. 39,965 Joel M. Freed, Reg. No. 25,101 Alan M. Grimaldi, Reg. No. 26,599 Alexander J. Hadjis, Reg. No. 36,540 Albert P. Halluin, Reg. No. 25,227 Michael N. Haynes, Reg. No. 40,014

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of HOWREY & SIMON, Box No. 34, 1299 PENNSYLVANIA Avenue, N.W., Washington, D.C. 20004-2402, power to insert in this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, executed by the undersigned on the date opposite their names.

Date:	August	<u>ዕባ</u> , 1998	Signature of Inventor:	Byeong-Yun Byeong-yun Nam	Nam
Date:	ing west	<u>° 1</u> , 1998	Signature of Inventor:	Byong - Sug Byeong-sun Ju	<i>Ju</i>